Tabrizi, B. Atty. Dkt. 1920/107

October 2, 2000

Attabase Attabas

Applicant(s): Tabrizi, B.

Serial No.: 09/677,291

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Date Filed: October 2, 2000

Invention: SEMICONDUCTOR PACKAGING

## **CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to Commissioner for Patents, Washington, D.C. 20231 on February 27, 2003.

Commissioner for Patents Washington, DC 20231

## RESPONSE E

Dear Sir:

In response to the Office Action mailed on November 26, 2002 entry of the following amendments is requested.

## In the Drawings:

Correction has been made to Fig. 1 to overcome the objection so that the figures now comply with 37 CFR 1.83(a).